

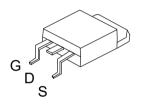
100V N-Channel MOSFET

Feature

- High density cell design for lower Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

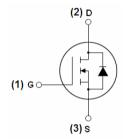


TO-263



Product Summary

V bs	100	V
R _{DS(on),Typ} @ V _{GS} =10V	31	mΩ
I D	33	Α



Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	33	А
Drain Current-Pulsed (Note 1)	I _{DM}	132	А
Maximum Power Dissipation(Tc=25°C)	P _D	70	W
Single pulse avalanche energy ^(Note 2)	E _{AS}	96	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case	Rелс	1.15	°C/W
Thermal Resistance, Junction-to-Ambient (PCB mount)	Reja	40	°C/W



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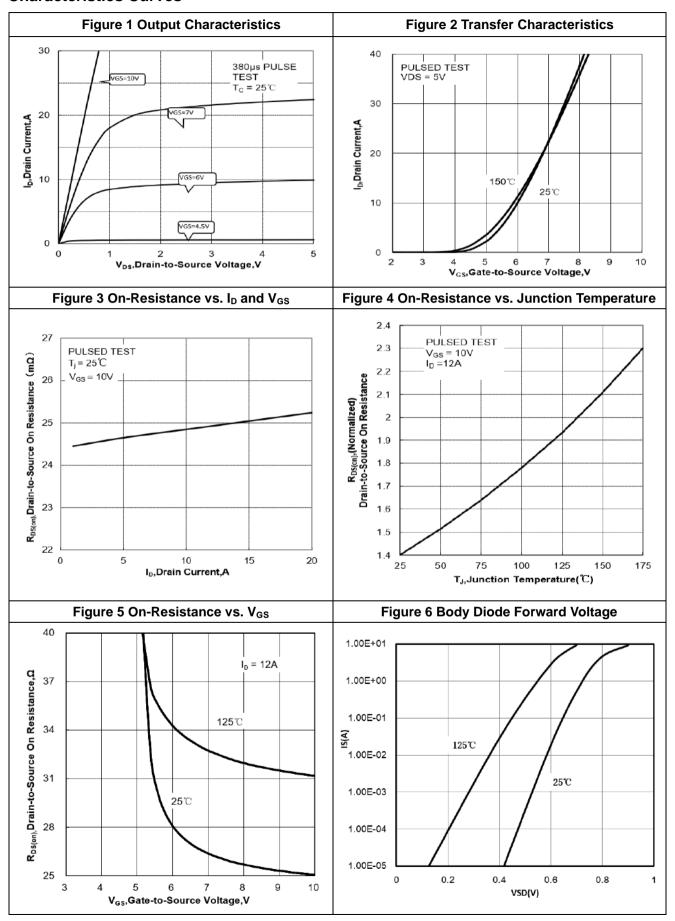
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	Igss	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250µA	1	1.6	2.4	V
		V _{GS} =10V, I _D =12A	-	31	35	mΩ
Drain-Source On-State Resistance ^(Note 3)	R _{DS(ON)}	V _{GS} =4.5V, I _D =12A	-	33	45	
Forward Transconductance	g FS	V _{DS} =5V,I _D =15A	-	11	-	S
Dynamic Characteristics						
Input Capacitance	Clss	- V _{DS} =25V,V _{GS} =0V, f=1.0MHz		2300	-	pF
Output Capacitance	Coss			215	-	pF
Reverse Transfer Capacitance	Crss			195	-	pF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	29	-	nS
Turn-on Rise Time	tr	V_{DD} =50V, ID=20A, V_{GS} =10V,R _{GEN} =10 Ω		13	-	nS
Turn-Off Delay Time	t _{d(off)}			58.2	-	nS
Turn-Off Fall Time	t _f			13.4	-	nS
Total Gate Charge	Qg	V _{DS} =80V,I _D =20A V _{GS} =10V		55	-	nC
Gate-Source Charge	Qgs			15	-	nC
Gate-Drain Charge	Q_{gd}			20	-	nC
Drain-Source Diode Characteristics	•			•		
Diode Forward Voltage	VsD	V _{GS} =0V,I _S =20A	-	-	1.2	V
Reverse Recovery Time	Trr	T: 25°C	-	58	-	nS
Reverse Recovery Charge	Qrr	Tj=25℃, IF=10A, di/dt=100A/uS ^(note3)		110	-	nC

Notes:

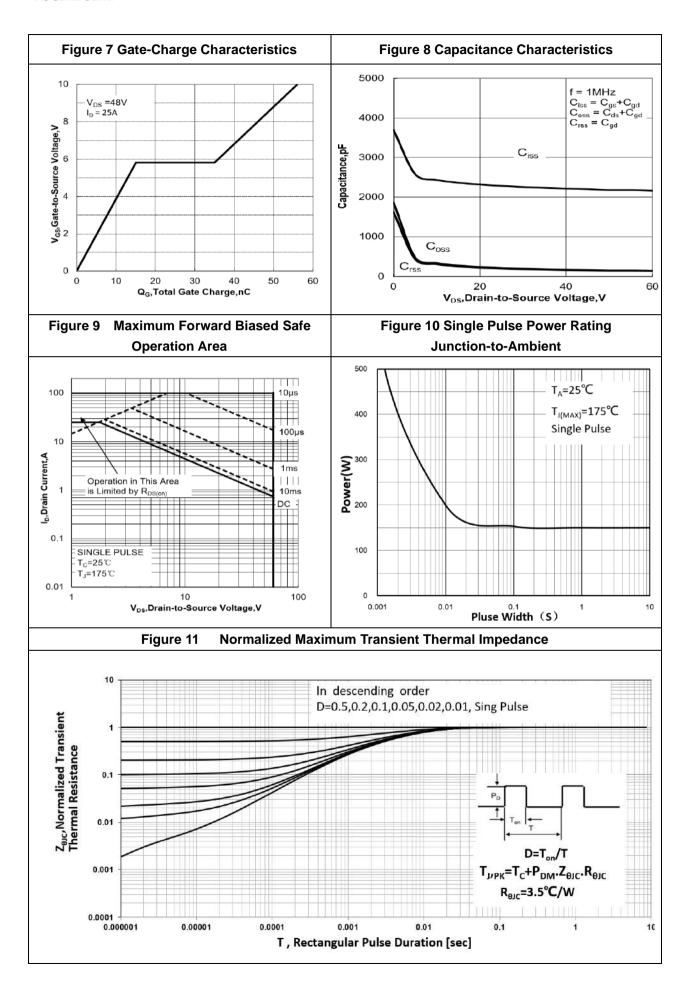
- Repetitive Rating: Pulse width limited by maximum junction temperature.
 E_{AS} condition: T_j=25°C,V_{DD}=50V,V_{GS}=10V,L=0.5mH,Rg=25Ω
 Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
 Guaranteed by design, not subject to production.



Characteristics Curves

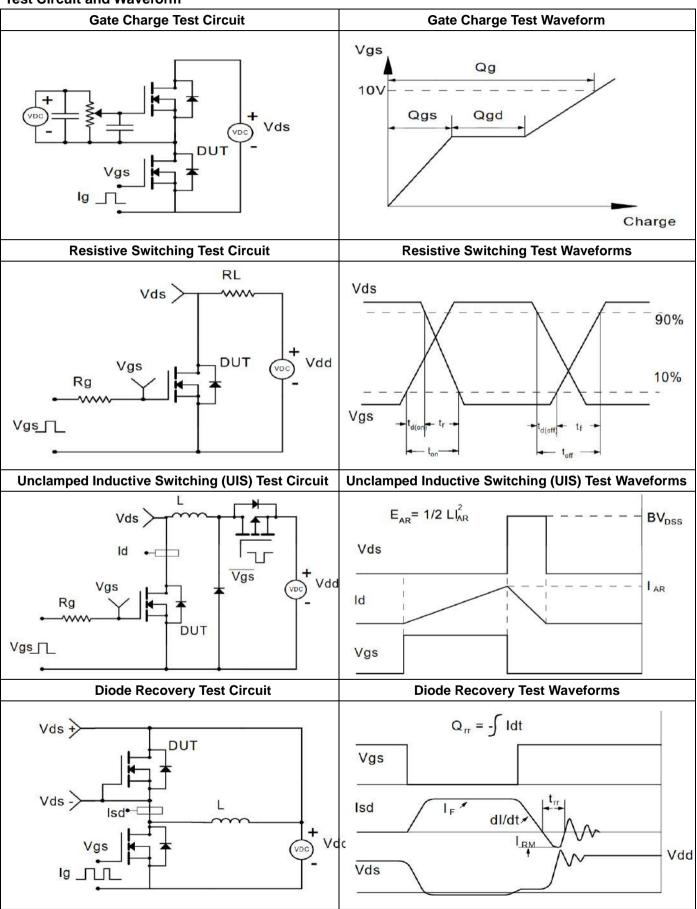








Test Circuit and Waveform





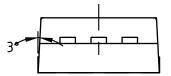
Ordering and Marking Information

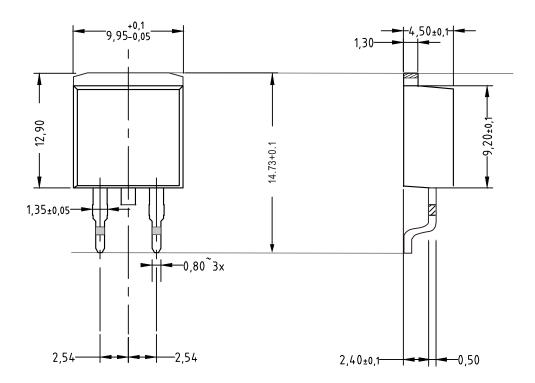
Ordering Device No.	Marking	Package	Packing	Quantity
ASDM540G-R	540	TO-263	Tape&Reel	800/Reel

PACKAGE	MARKING
TO-263	AS Date Code Date Code



TO-263







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